NSN 5962-00-271-1596

Memory Microcircuit - Page 1 of 1

Fiig: A458a0



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Body Length:
Between 0.240 inches and 0.260 inches
Body Width:
Between 0.240 inches and 0.260 inches
Body Height:
Between 0.030 inches and 0.070 inches
Maximum Power Dissipation Rating:
450.0 milliwatts
Operating Tempurature Range:
-55.0/+125.0 degrees celsius
Storage Tempurature Range:
-65.0/+150.0 degrees celsius
Features Provided:
Monolithic and hermetically sealed and positive outputs and medium speed
Inclosure Material:
Ceramic and glass
Inclosure Configuration:
Flat pack
Output Logic Form:
Current-mode logic
Input Circuit Pattern:
6 input
Terminal Surface Treatment:
Solder
Voltage Rating And Type Per Characteristic:
20.0 volts power source
Time Rating Per Chacteristic:
100.00 nanoseconds propagation delay time, low to high level output
Memory Device Type:
Rom
Test Data Document:
82679-nw180 drawing (this is the basic governing drawing, such as a contractor drawing, original equipment manufacturer drawing, etc.
excludes any specification, standard or other document that may be referenced in a basic governing drawing)
Terminal Type And Quantity:
14 flat leads
Shelf Life:
N/a
Unit Of Measure:

Demilitarization:
Yes - demil/mli